

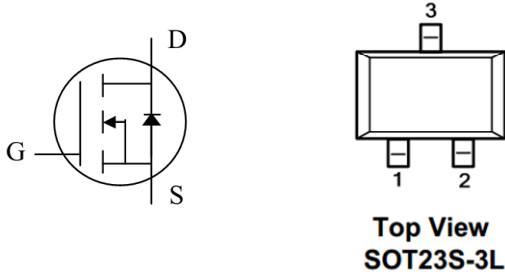
## N-Channel 20V MOSFET

### Features:

- Surface-mounted package
- High Density Cell Design
- Halogen free

### Application

- Ultra Low On-Resistance



$B_{V_{DS}} = 20V$  ,  
 $R_{DS(ON)} < 41m\Omega @ V_{GS} = 4.5V$   
 $R_{DS(ON)} < 47m\Omega @ V_{GS} = 2.5V$   
 $R_{DS(ON)} < 57m\Omega @ V_{GS} = 1.8V$   
 $I_D = 4.9A$

### Absolute Maximum Ratings (T<sub>A</sub>=25°C Unless Otherwise Noted)

Parameter	Symbol	LTC2312	Unit
	Marking	N12	
Drain-Source Voltage	V <sub>DSS</sub>	20	V
Gate-Source Voltage	V <sub>GS</sub>	±8	V
Continuous Drain Current <sup>(3)</sup>	I <sub>D</sub>	Ta=25°C	4.9
		Ta=70°C	3.4
Pulsed Drain Current <sup>(1, 2)</sup>	I <sub>DM</sub>	15	A
Power Dissipation <sup>(1)</sup>	P <sub>D</sub>	0.75	W
Linear Derating Factor		1.3	°C/W
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to 150	°C

### Thermal Characteristics

Symbol	Characteristic	Max.	Units
R <sub>θJA</sub>	Junction-to-Ambient <sup>(3)</sup>	140	°C/W

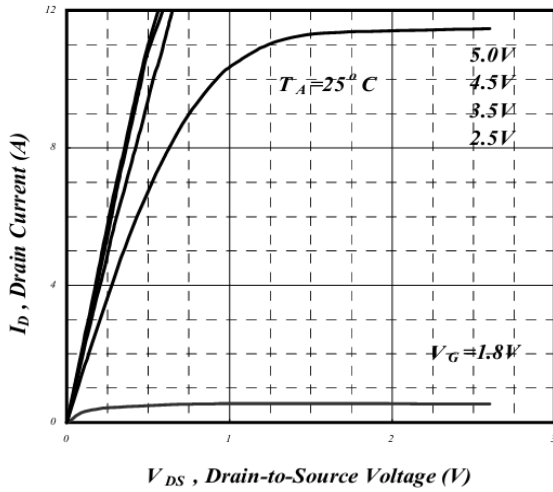
Note :

- (1) Pulse width limited by Max. junction temperature
- (2) Pulse width ≤ 300us, duty cycle, ≤ 2%
- (3) Surface mounted on 1 in<sup>2</sup> copper PCB board

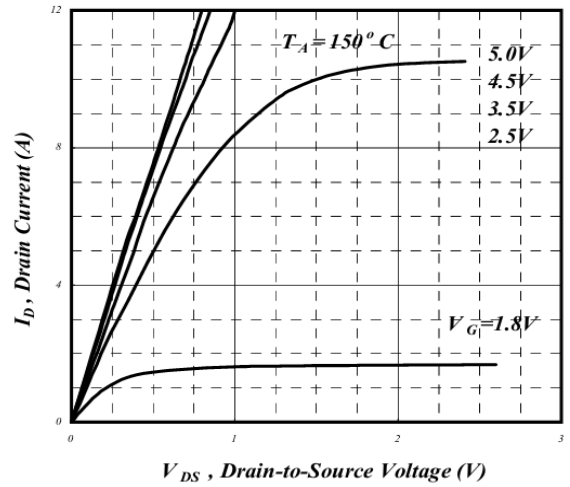
**N-Channel 20V MOSFET**
**Electrical Characteristics** ( $T_A = 25^\circ\text{C}$  Unless Otherwise Specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
<b>Static</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	20	--	--	V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	0.4	0.6	1	V
$I_{GSS}$	Gate-Body Leakage	$V_{DS}=0V, V_{GS}=\pm 8V$	--	--	$\pm 100$	nA
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=20V, V_{GS}=0V$	--	--	1	$\mu A$
$R_{DS(on)}$	Drain-Source On-Resistance	$V_{GS}=4.5V, I_D=5A$	--	21	41	m $\Omega$
		$V_{GS}=2.5V, I_D=4.5A$	--	24	47	m $\Omega$
		$V_{GS}=1.8V, I_D=4A$	--	31	57	m $\Omega$
$V_{SD}$	Diode Forward voltage	$I_S=1.7A, V_{GS}=0V$	--	--	1.2	V
$g_{FS}$	Forward Transconductance	$I_D=5A, V_{DS}=10V$	--	40	--	S
$I_S$	Maximum Diode Forward Current		--	--	1.7	A
<b>Dynamic</b>						
$C_{iss}$	Input Capacitance	$V_{DS}=8V, V_{GS}=0V,$ $f=1.0MHz$	--	700	--	pF
$C_{oss}$	Output Capacitance		--	100	--	
$C_{riss}$	Reverse Transfer Capacitance		--	70	--	
<b>Switch Parameters</b>						
$Q_g$	Total Gate Charge	$V_{DS}=10V, V_{GS}=4.5V$ $I_D=5A,$	--	11.2	--	nC
$Q_{gs}$	Gate Source Charge		--	1.4	--	
$Q_{gd}$	Gate Drain Charge		--	2.2	--	
$t_{d(on)}$	Turn-On Delay Time	$V_{DS}=10V, V_{GS}=4.5V,$ $I_D=1A, R_{GEN}=6\Omega,$	--	2	25	ns
$t_r$	Turn-On Rise Time		--	25	60	
$t_{d(off)}$	Turn-Off Delay Time		--	25	70	
$t_f$	Turn-Off Fall Time		--	20	45	

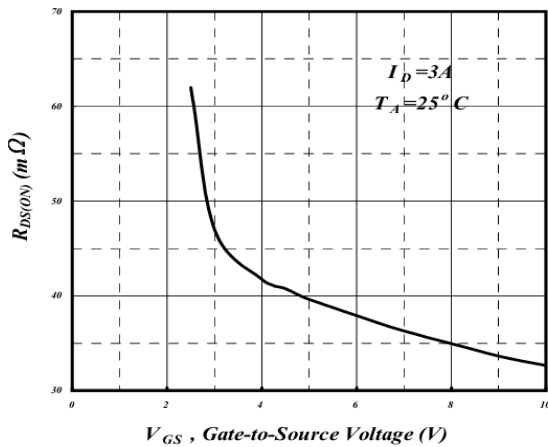
N-Channel 20V MOSFET



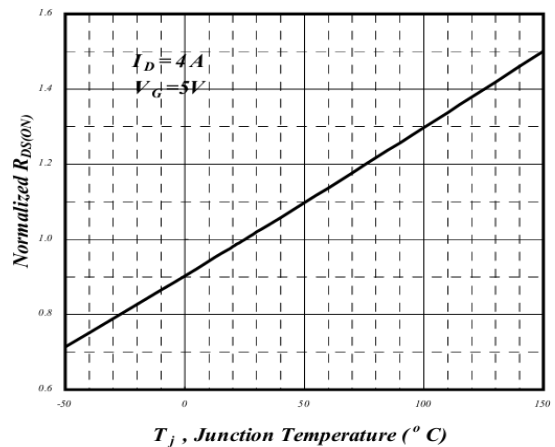
**Fig 1. Typical Output Characteristics**



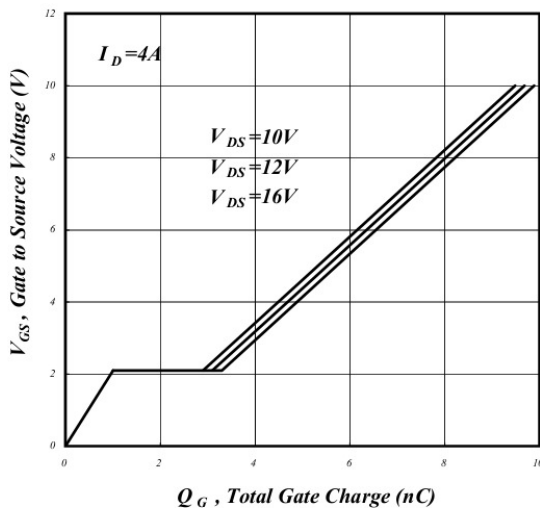
**Fig 2. Typical Output Characteristics**



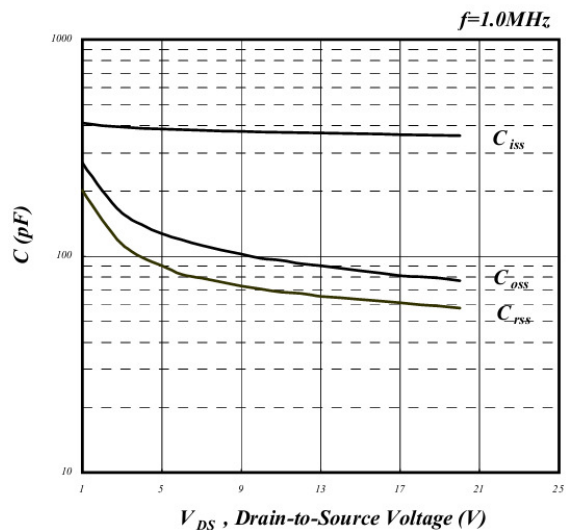
**Fig 3. On-Resistance v.s. Gate Voltage**



**Fig 4. Normalized On-Resistance v.s. Junction Temperature**

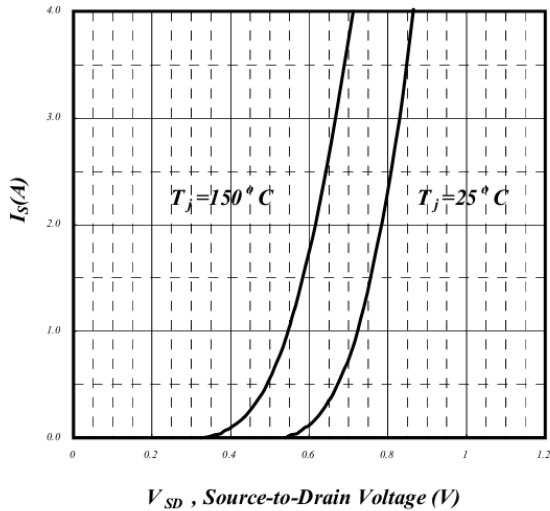


**Fig 7. Gate Charge Characteristics**

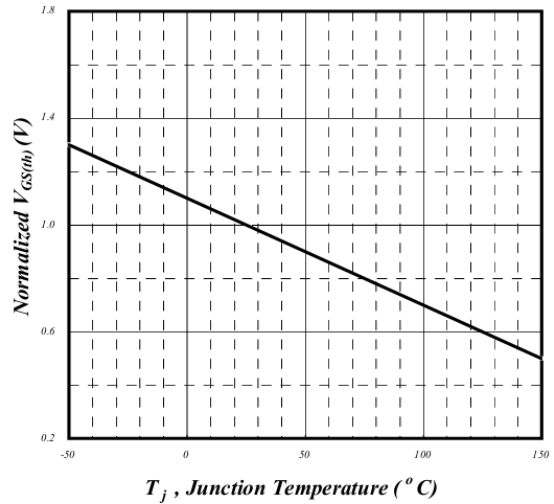


**Fig 8. Typical Capacitance Characteristics**

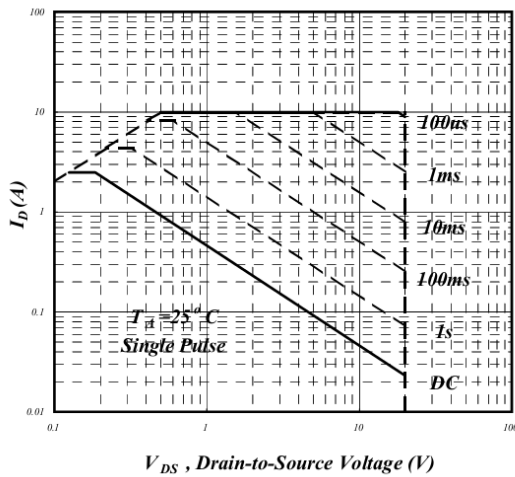
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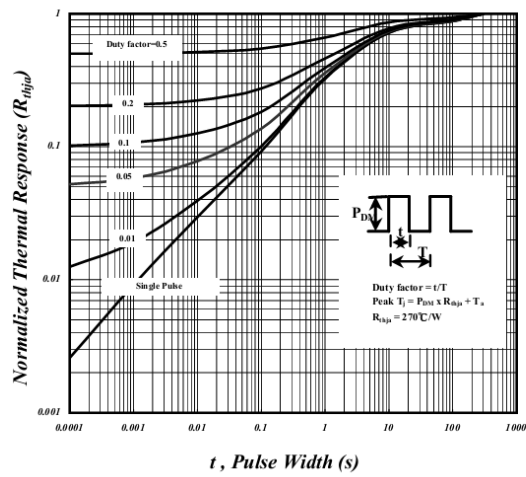
**Fig 5. Forward Characteristic of Reverse Diode**



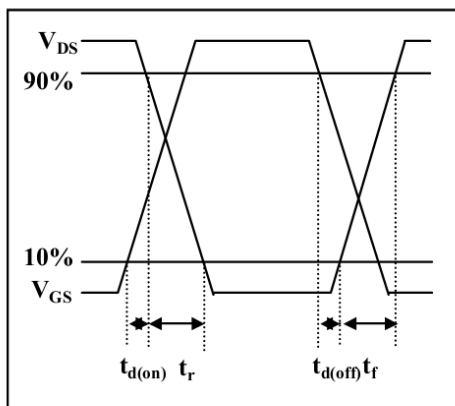
**Fig 6. Gate Threshold Voltage v.s. Junction Temperature**



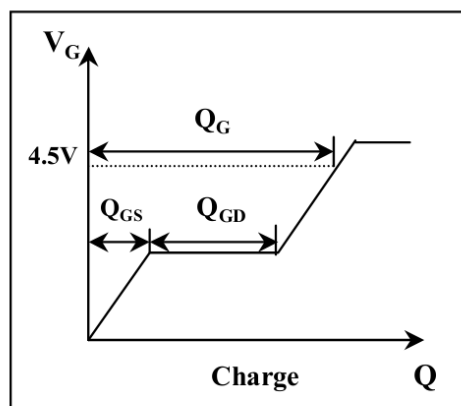
**Fig 9. Maximum Safe Operating Area**



**Fig 10. Effective Transient Thermal Impedance**

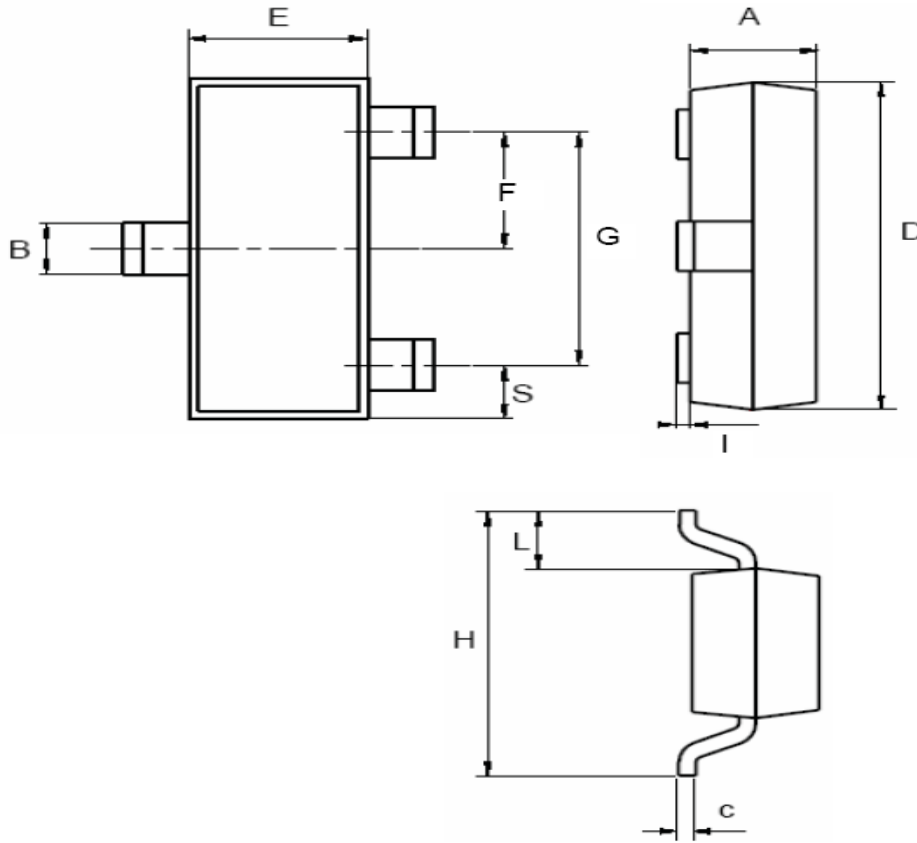


**Fig 11. Switching Time Circuit**



**Fig 12. Gate Charge Circuit**

N-Channel 20V MOSFET



SOT-23		
DIM.	MIN.	MAX.
A	0.89	1.40
B	0.30	0.51
C	0.085	0.18
D	2.75	3.04
E	1.20	1.60
F	0.85	1.05
G	1.70	2.10
H	2.10	2.75
I	0.0	0.1
L	0.60 typ.	
S	0.35	0.65
All Dimensions in millimeter		

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